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(12) **United States Design Patent**  
**Chen**

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(54) **HEADPHONE**

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(\*) Notice: This patent is subject to a terminal disclaimer.

(\*\*) Term: **15 Years**

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(52) **U.S. Cl.**

USPC ..... **D14/205**

(58) **Field of Classification Search**

USPC ..... D14/205, 188, 192; D29/112; 2/209; 381/380, 381, 378-379, 374; 455/90.3, 455/575.1, 569.1

CPC ..... H04R 25/00; H04R 25/02; H04R 1/10; H04R 1/1066; H04R 1/1016; H04R 5/033; H04R 5/0335; H04R 1/1091

See application file for complete search history.

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*Primary Examiner* — Paula Allen Greene

(57) **CLAIM**

The ornamental design for a headphone, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a headphone showing my new design;

FIG. 2 is a front elevation view thereof;

FIG. 3 is a rear elevation view thereof;

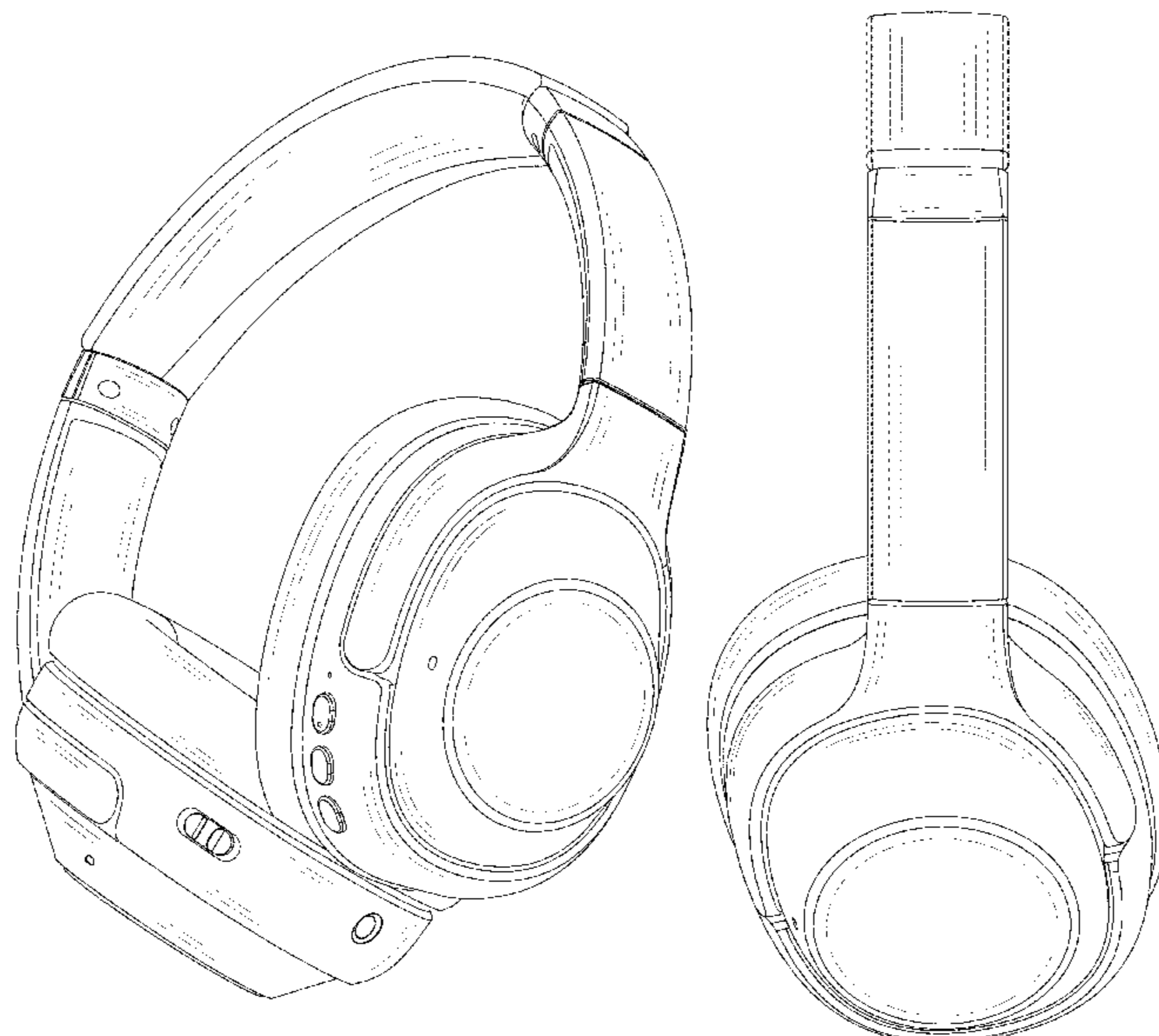
FIG. 4 is a left side elevation view thereof;

FIG. 5 is a right side elevation view thereof;

FIG. 6 is a top plan view thereof; and,

FIG. 7 is a bottom plan view thereof.

**1 Claim, 7 Drawing Sheets**



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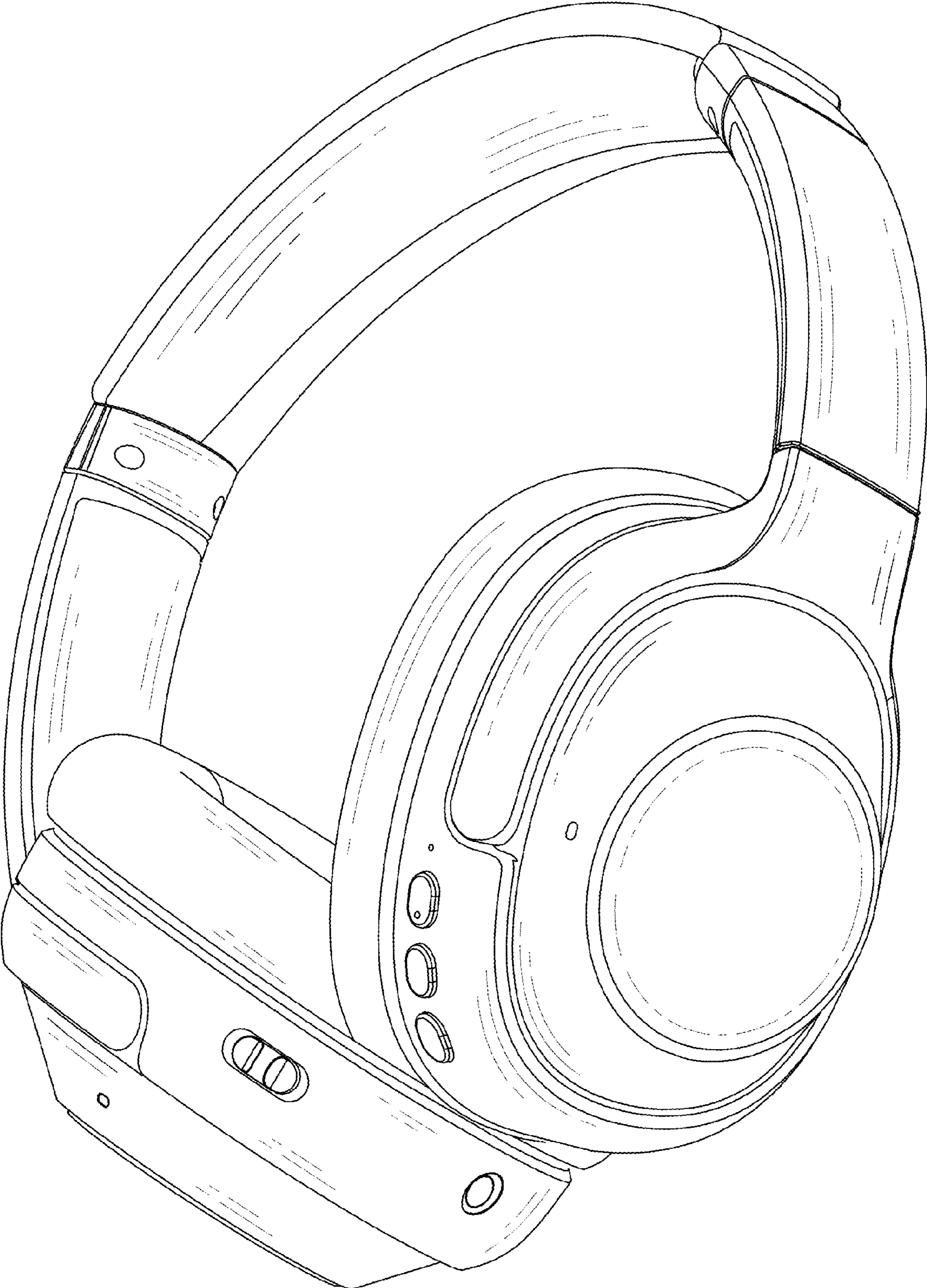


FIG.1



FIG.2

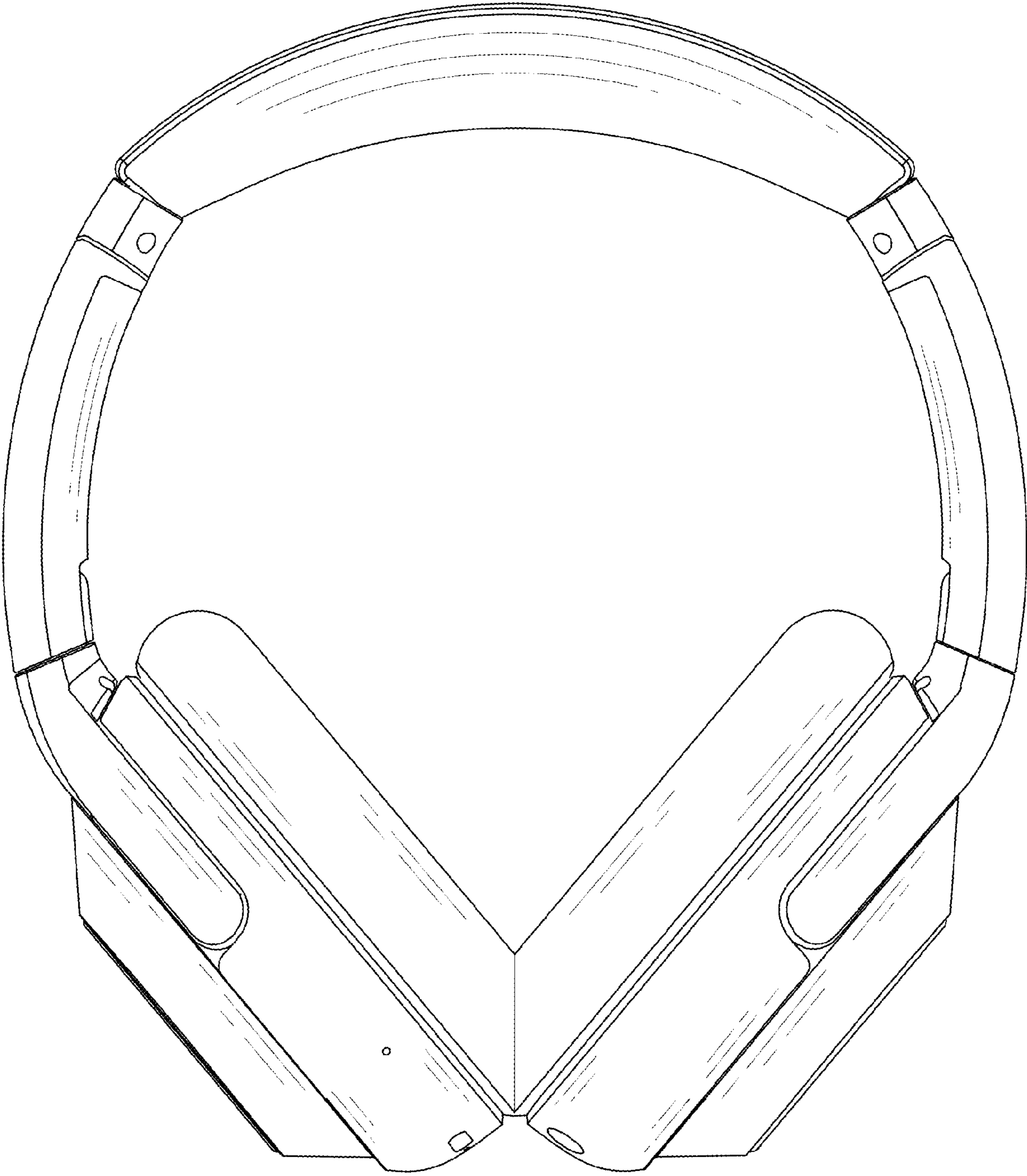


FIG.3

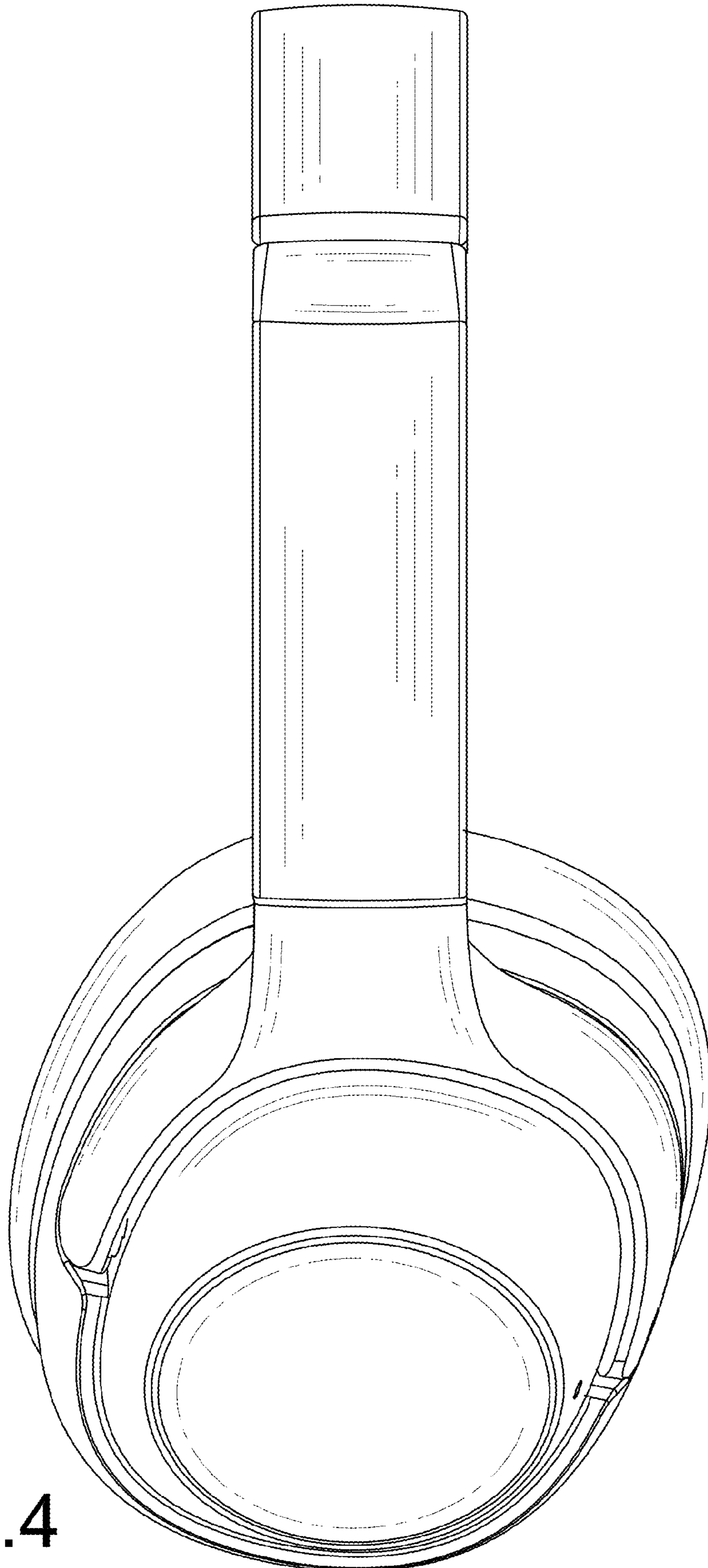


FIG.4

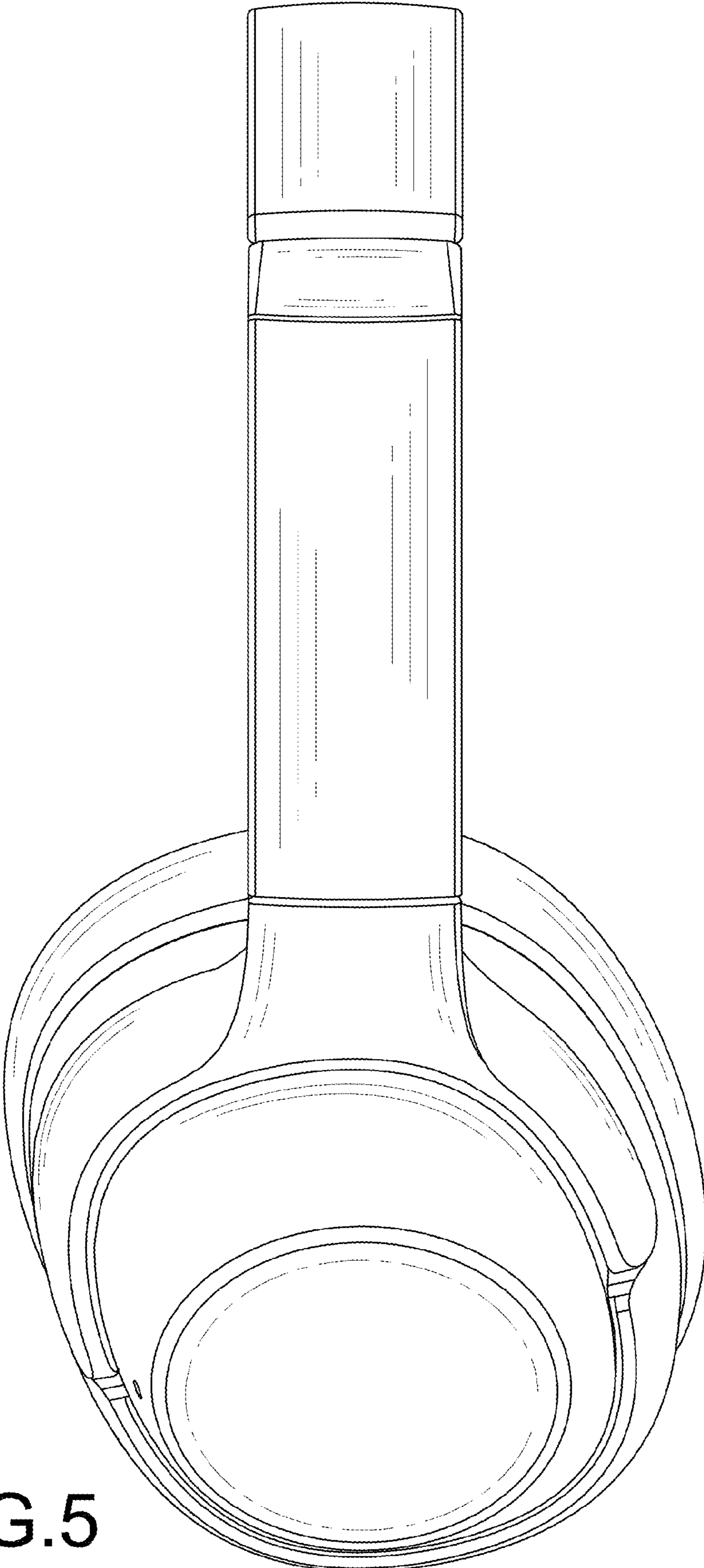


FIG. 5

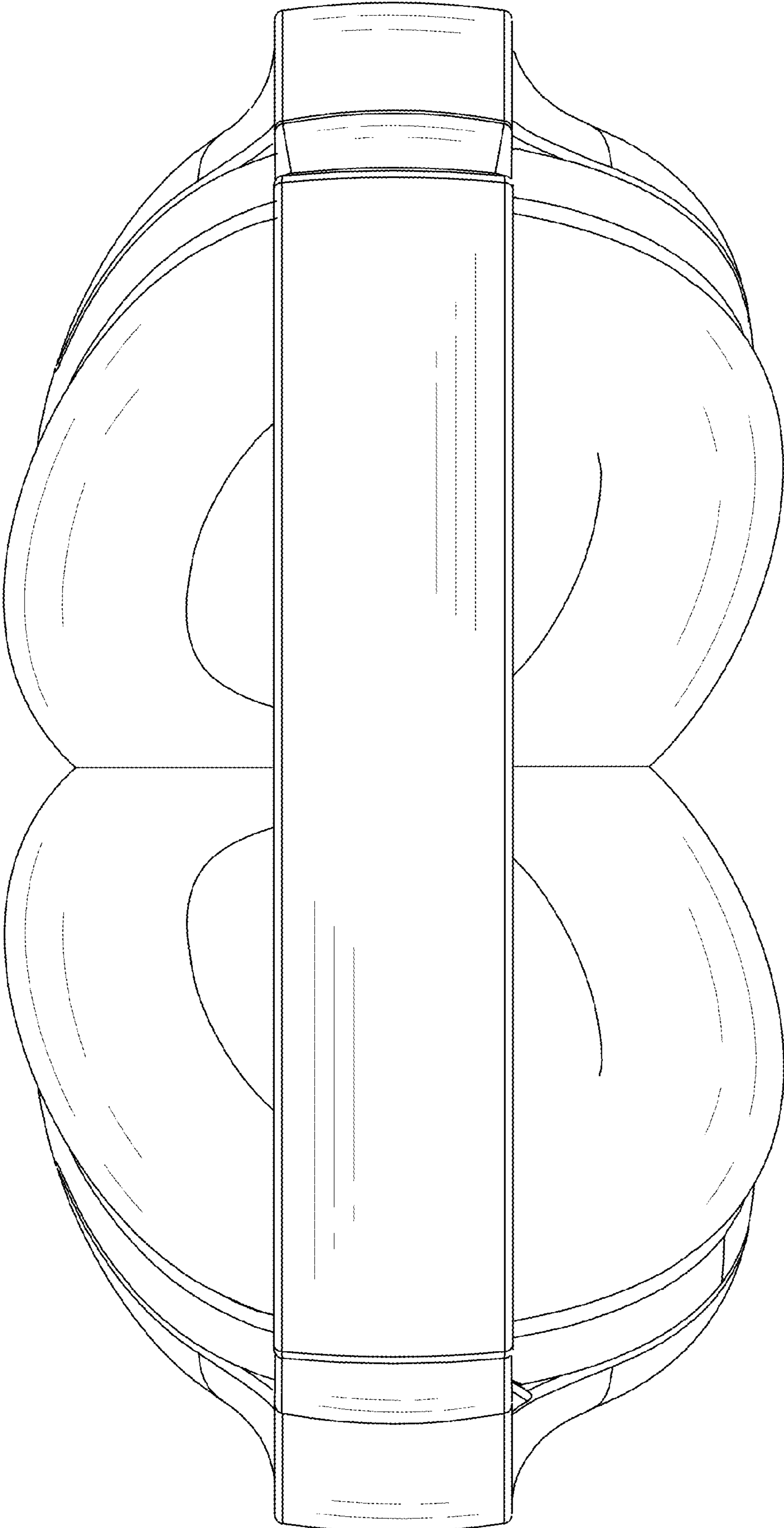


FIG.6



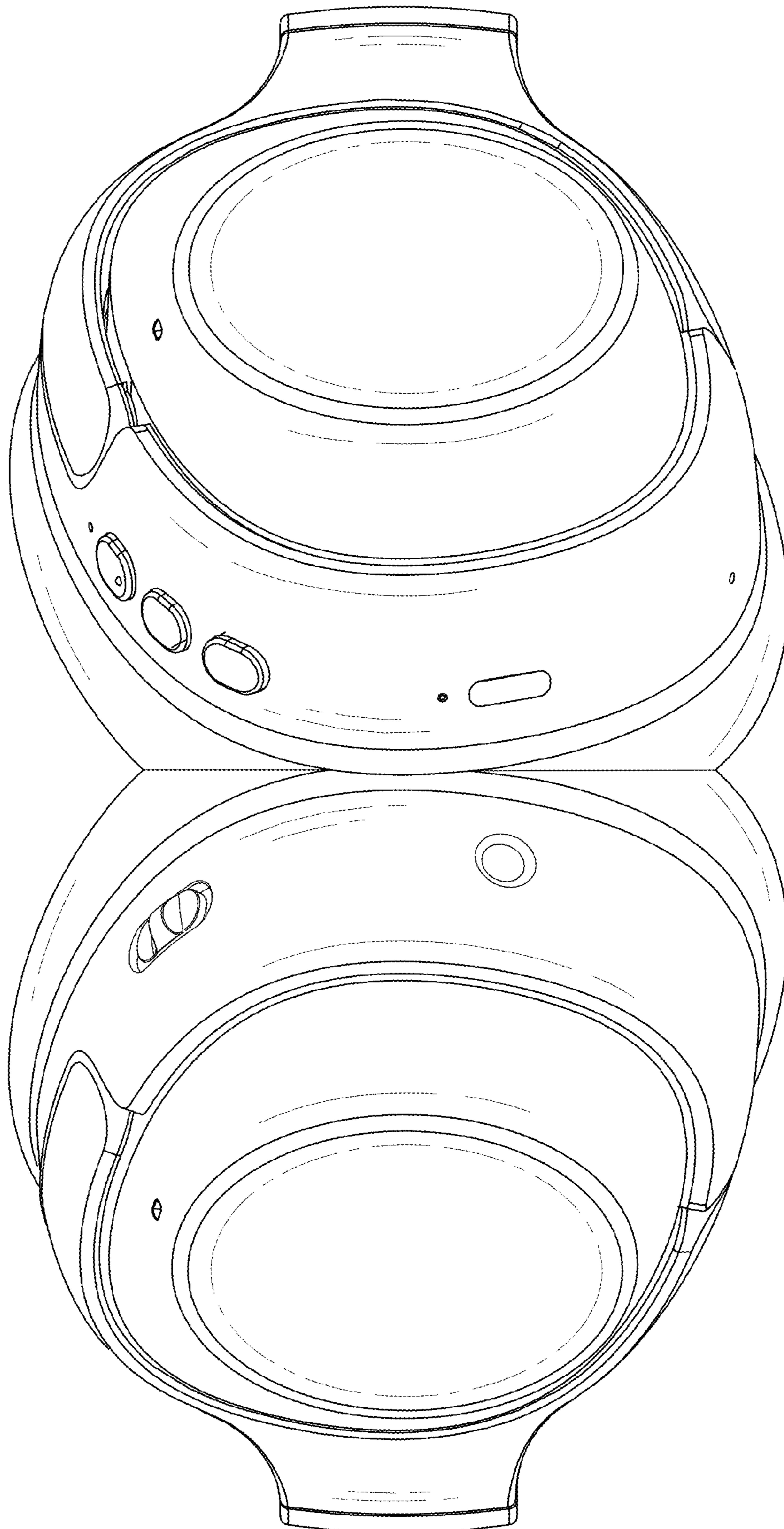


FIG.7